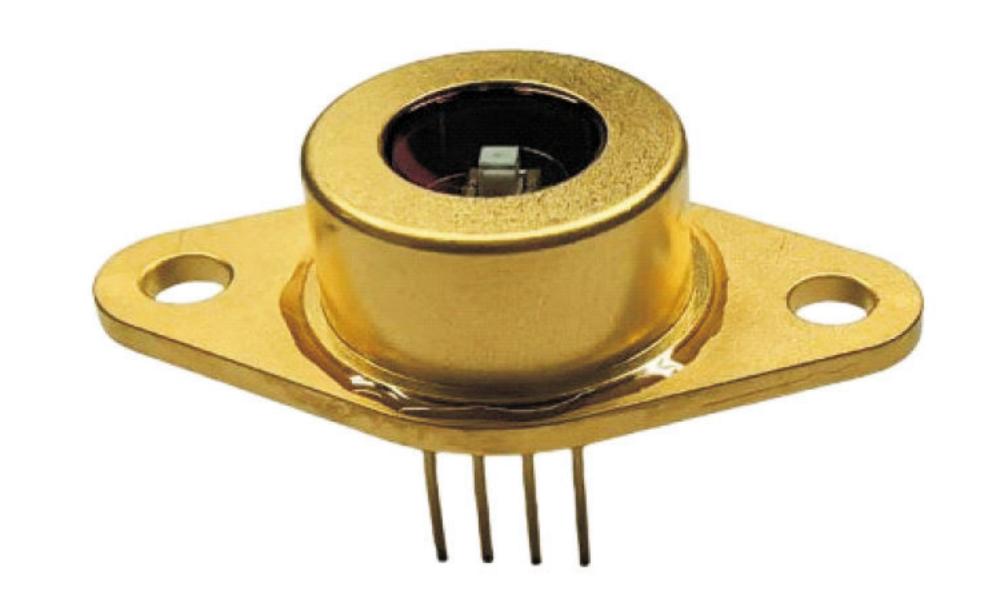
### **OP411D InGaAs SPAD Detector**

#### Product Features

- O Working wavelength: 0.95μm~1.65μm;
- High detection sensitivity (single photon level detection capability);
- Internal integrated three-stage cooler;
- Free Space Optical/FC Pluggable Optical Interface/Multimode Fiber (62.5um) optional.



# Main photoelectric indicators

### Linear mode parameters

Characteristic parameters	Test conditions (TC=25±5°C unless otherwise specified)	Minimal	Greatest	Unit
Effective detection surface diameter d		25	-	μm
Spectral Response Range		950	1650	nm
Reverse breakdown voltage VBR	<i>I</i> <sub>D</sub> = 10 μA, T <sub>c</sub> = 22°C	60	85	V
Responsiveness Re	$\lambda=1.55\mu m$ , $V_R=V_{BR}-1V$ , $\varphi e=1\mu w$	8	_	A/W
Dark Current ID	$V_R = V_{BR} - 1V$ , $\varphi e = 0$	-0	1	nA
Capacitance Ctot	$V_R = V_{BR} - 1V$ , $f = 1MHz$	<b>-</b> 0	0.6	pF
Temperature coefficient of breakdown voltage η	$T_C = -45 \sim +30^{\circ}\text{C}$ , IR = 10 µA, $\varphi e = 0$	0.10	0.15	V/°C

### Geiger mode parameters

parameters	Test conditions	Min	Max	Unit
Single Photon Detection Efficiency <i>PDE</i>	$T_A = -40 \pm 5^{\circ}\text{C}, \mu = 1, f_g = 1.25 \text{ kHz}, f_g = 625 \text{ kHz},$ DCR $\leq 3.0 \text{ kcps}, \lambda = 1.55 \mu\text{m}$	20		%
Dark Count Rate DCR	$T_A$ = -40±5°C,µ=1, $f_g$ = 1.25 kHz, SPDE ≥ 20%, $\lambda$ = 1.55 µm		3	kcps
Post-Pulse Probability <i>APP</i> (500 ns)	$T_A = -40\pm5^{\circ}\text{C}, \ \mu=1, f_g = 1.25 \ \text{Ghz}, f_g = 625 \text{kHz}, \ \text{DCR} \le 3.0 \ \text{kHz}, \ \text{SPDE} \ge 20\%, \ \lambda = 1.55 \ \mu\text{m}$	22	4	%
Time Jitter T <sub>J</sub>	SPDE = 20%		200	ps

Note :  $\lambda$ : Spectral response;  $T_A$ : device temperature;  $\mu$ : under a certain average photon number per pulse;  $f_p$ : versus the photon trigger repetition rate.

## Absolute maximum ratings & Optical values

Serial Number Parameters		Parameters	Rated Value
1   2   3   3   4   5   5   6   7   8   9	1	Storage temperature TsTG	-50°C~+85°C
	2	Operating ambient temperature Tc	-50°C~60°C
	3	Welding temperature $T_{sld}$ (time)	260°C(10s)
	4	Reverse DC bias voltage Voc	V <sub>BR</sub> +5V
	5	Input optical power φe (continuous)	1mW
	6	Forward current if (continuous)	200μΑ
	7	Electrostatic Discharge Sensitivity ESD	≥300V
	8	TEC Voltage	6.8 V
	9	TEC Current	1.0 A

Serial N	Serial Number Parameters		Rated Value	
Optical	1	APD chip operating temperature T <sub>th</sub>	-50°C~-30°C	
values	2	Reverse DC bias voltage VDC	V <sub>BR</sub> +1V to V <sub>BR</sub> +5V	

### Typical Characteristic Curve

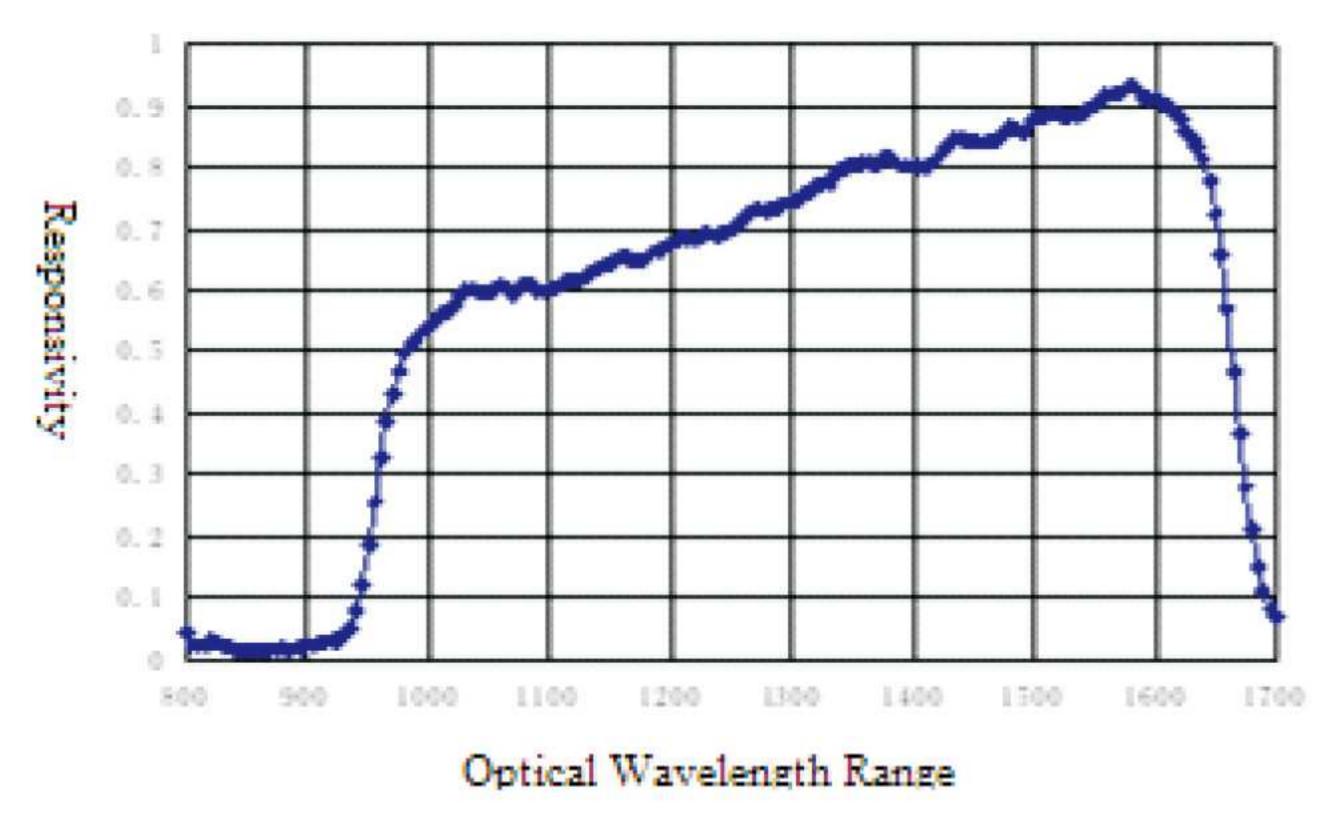


Fig. 1 InGaAs spectral response characteristic curve

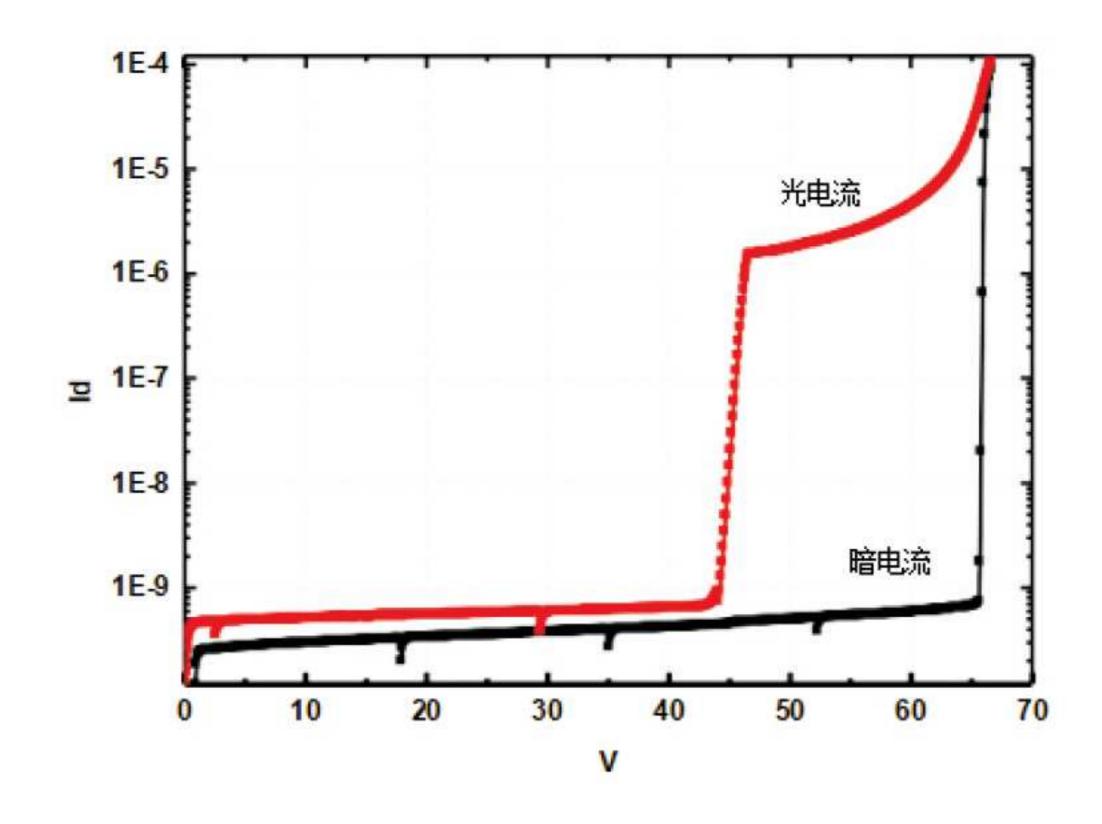
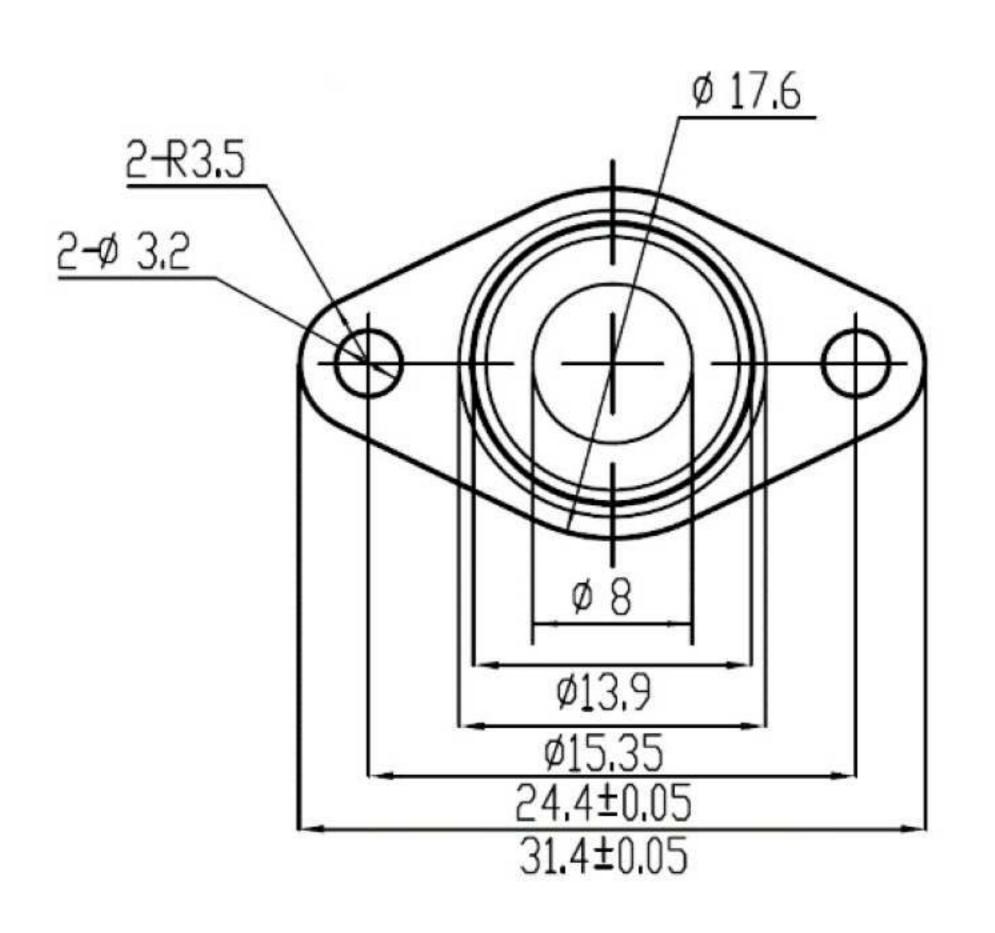


Fig. 2 Photocurrent/dark current curve

## Shape, Dimensions and Pinout Definitions (in mm)



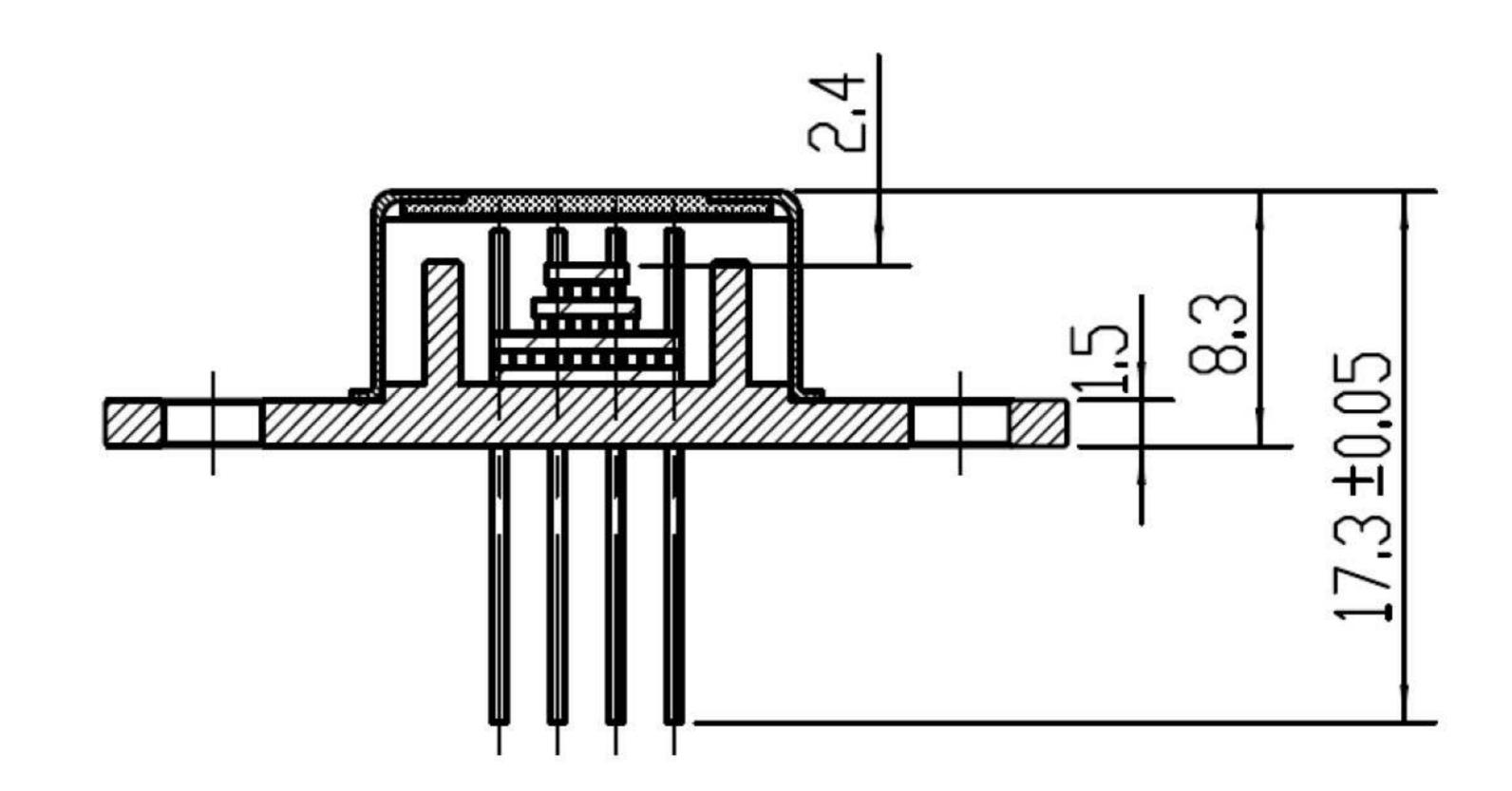
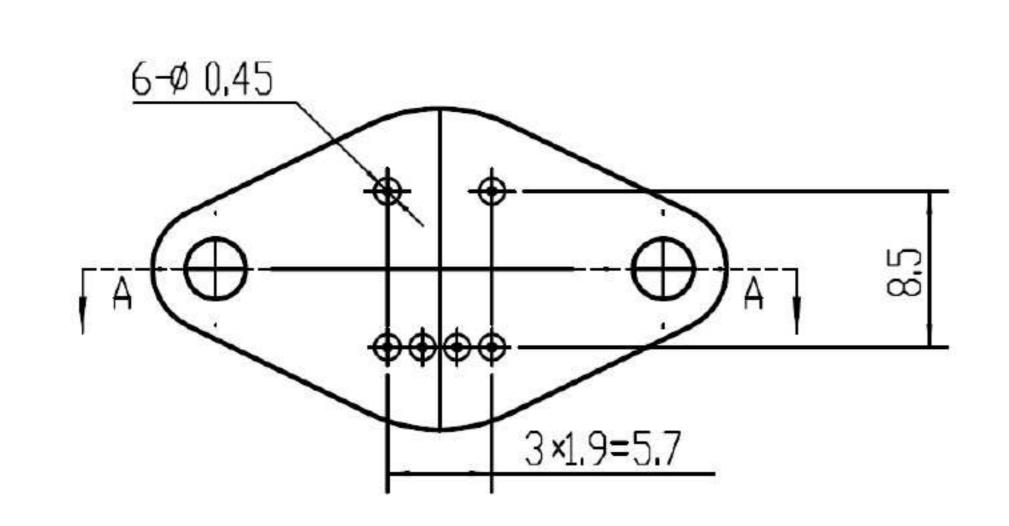


Fig. 3 External Dimensions 1 (Unmarked dimension tolerance ±0.1mm)



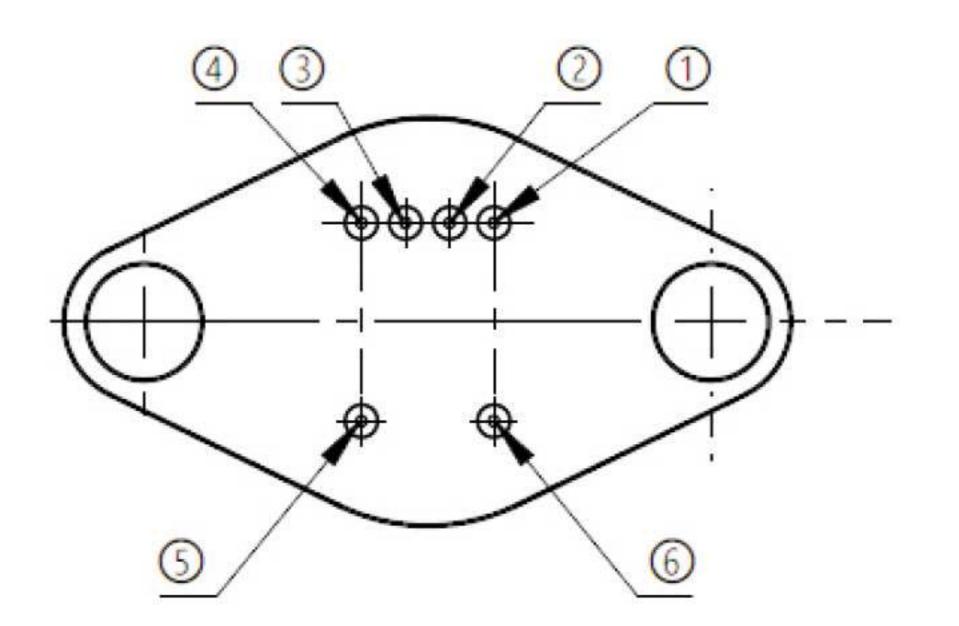
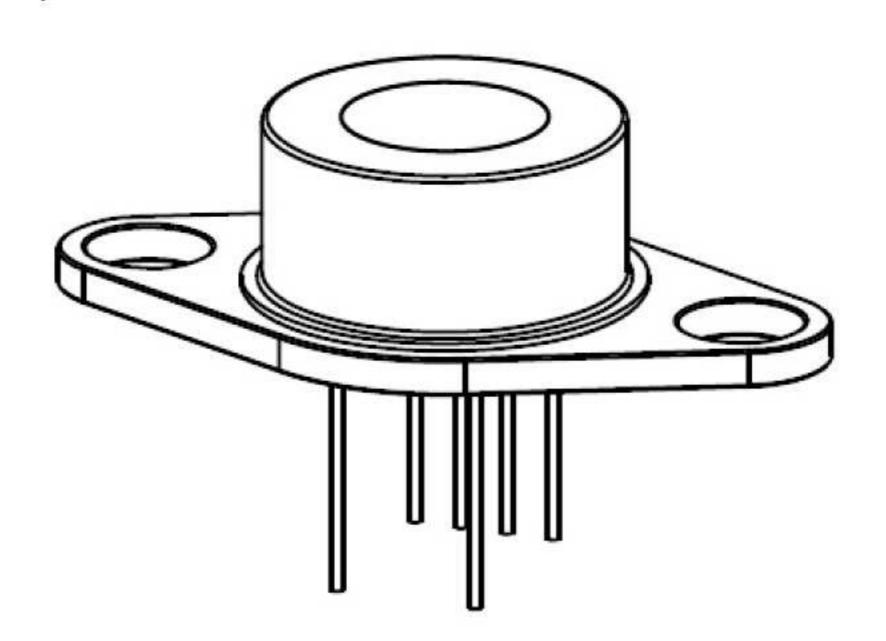


Fig. 4 External Dimensions 2 (Unmarked dimension tolerance ±0.1mm)



NO.	Pin Definitions	Pin Function
1	TEC-	TEC Negative
2	NTC	Temperature Sensitive Resistor Terminal
3	NTC	Temperature Sensitive Resistor Terminal
4	TEC+	TEC Positive
5	APD-N	Avalanche Photodiode Negative
6	APD-P	Avalanche Photodiode Positive

#### **TEC\NTC Electrical Characteristics**

NTC(Negative Temperature Coefficient) :  $R_T = 10k\Omega@25^{\circ}C$ ,  $\beta = 3450$ , 5%. TEC(Thermoelectric cooler) :  $I_{MAX} = 1.0 \, A$ ,  $V_{MAX} = 6.8 \, V$ ,  $I_{MAX} = 200^{\circ}C$ .